





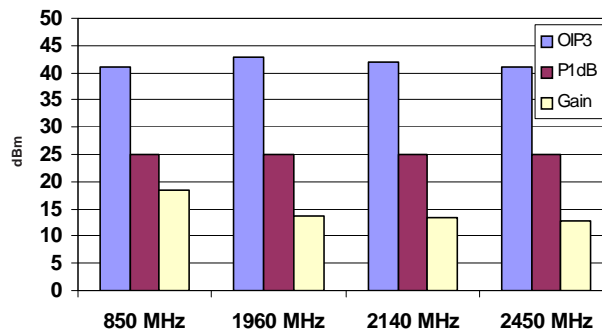
### Product Description

RFMD's SXA-389B amplifier is a high efficiency GaAs Heterojunction Bipolar Transistor (HBT) MMIC housed in low-cost surface mountable plastic package. These HBT MMICs are fabricated using molecular beam epitaxial growth technology which produces reliable and consistent performance from wafer to wafer and lot to lot. These amplifiers are specially designed for use as driver devices for infrastructure equipment in the 400 MHz to 2500 MHz cellular, ISM, WLL, PCS, WCDMA applications. Its high linearity makes it an ideal choice for multi-carrier as well as digital applications.

#### Optimum Technology Matching® Applied

- GaAs HBT
- GaAs MESFET
- InGaP HBT
- SiGe BiCMOS
- Si BiCMOS
- SiGe HBT
- GaAs pHEMT
- Si CMOS
- Si BJT
- GaN HEMT
- InP HBT
- RF MEMS
- LDMOS

Typical OIP<sub>3</sub>, P<sub>1dB</sub>, Gain



### Features

- Available in RFMD Green, RoHS Compliant, and Pb-Free (Z Part Number)
- Lower R<sub>TH</sub> for increased MTTF 10<sup>8</sup> Hours at T<sub>Lead</sub>=85°C
- On-Chip Active Bias Control, Single 5V Supply
- Excellent Linearity: +43dBm Typ. OIP<sub>3</sub> at 1960MHz
- High P<sub>1dB</sub> : +25dBm Typ.
- High Gain: +18.5dB at 850MHz
- Efficient: Consumes Only 575mW

### Applications

- W-CDMA, PCS, Cellular Systems
- Multi-Carrier Applications

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Small Signal Gain		18.4		dB	850MHz
		13.6		dB	1960MHz
	12.5	13.5	15.0	dB	2140MHz
		12.8		dB	2450MHz
Output Power at 1dB Compression		25.0		dBm	850MHz
		25.0		dBm	1960MHz
	24.0	25.0		dBm	2140MHz
		25.0		dBm	2450MHz
Output Third Order Intercept Point		41.0		dBm	850MHz, P <sub>OUT</sub> per tone = +11dBm, Tone Spacing = 1MHz
		43.0		dBm	1960MHz
	39.0	42.0		dBm	2140MHz
		41.0		dBm	2450MHz
Noise Figure		4.5		dB	850MHz
		4.8	6.3	dB	1960MHz
		5.0		dB	2140MHz
		5.7		dB	2450MHz
Input VSWR		1.2:1			850MHz
		1.3:1	2.0:1		1960MHz
		1.2:1			2140MHz
		1.2:1			2450MHz
Operating Dissipated Power		575.0		mW	
Device Operating Current	90	115	135	mA	V <sub>CC</sub> =5V
Thermal Resistance		70		°C/W	junction to backside

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## Absolute Maximum Ratings

Parameter	Rating	Unit
Max Device Current ( $I_D$ )	240	mA
Max Device Voltage ( $V_{CC}$ )	6	V
Max RF Input Power	100	mW
Max Dissipated Power	1500	mW
Max Junction Temperature ( $T_J$ )	165	°C
Operating Temperature Range ( $T_L$ )	-40 to + 85	°C
Max Storage Temperature	150	°C
ESD Rating - Human Body Model (HBM)	Class 1C	
Moisture Sensitivity Level	MSL 2	



**Caution!** ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EU Directive 2002/95/EC (at time of this document revision).

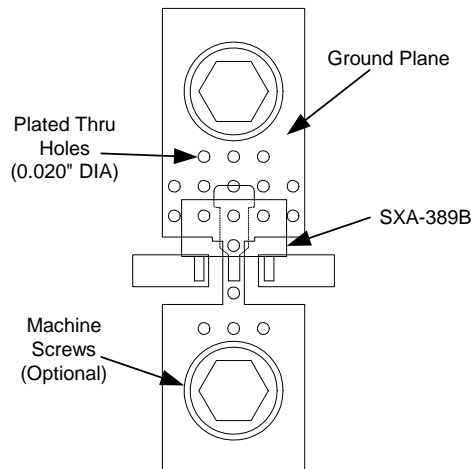
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Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one.

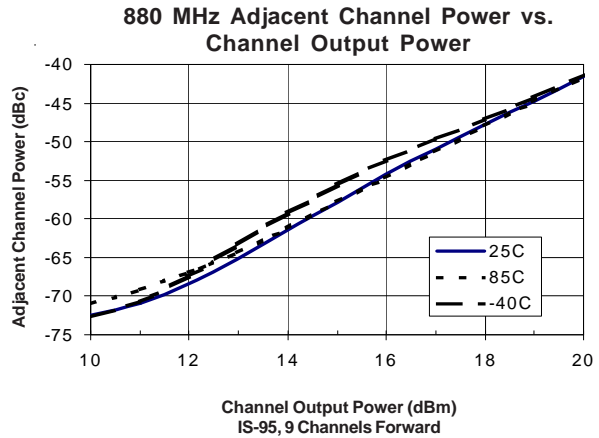
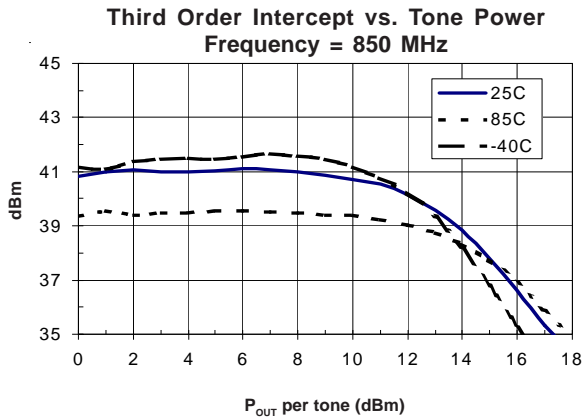
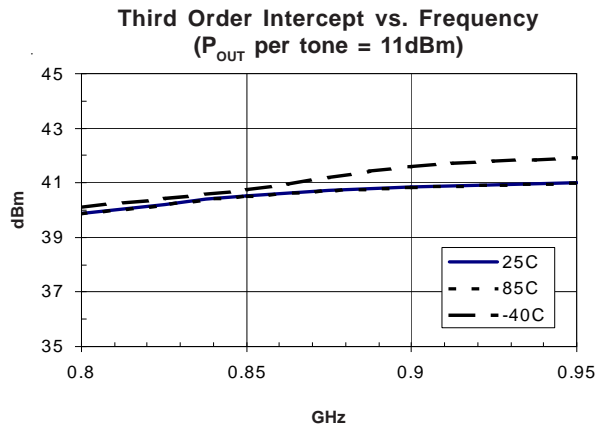
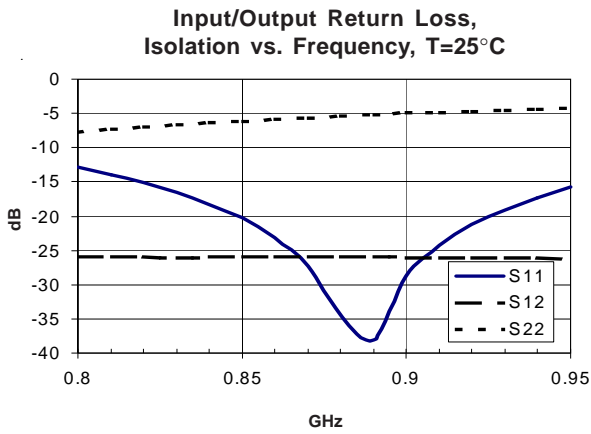
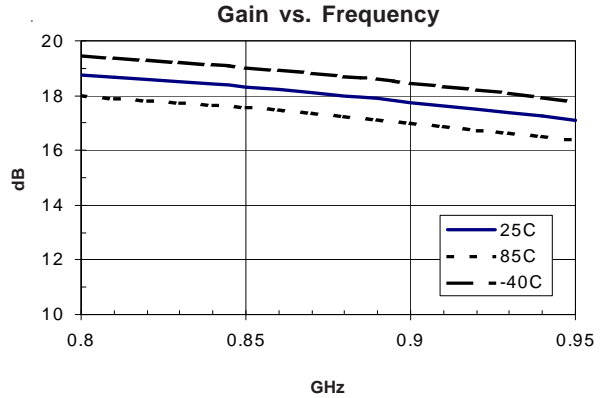
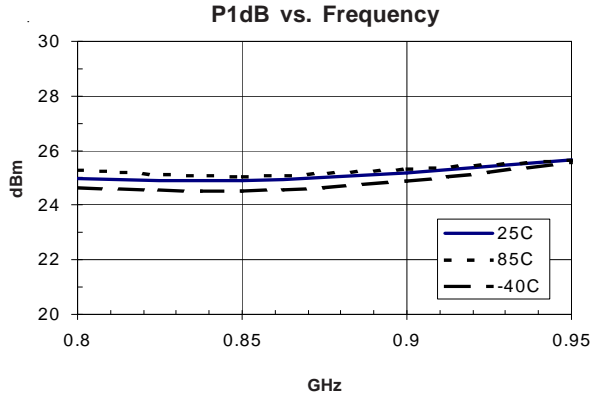
Bias Conditions should also satisfy the following expression:

$$I_D V_D < (T_J - T_L) / R_{TH, j-l}$$

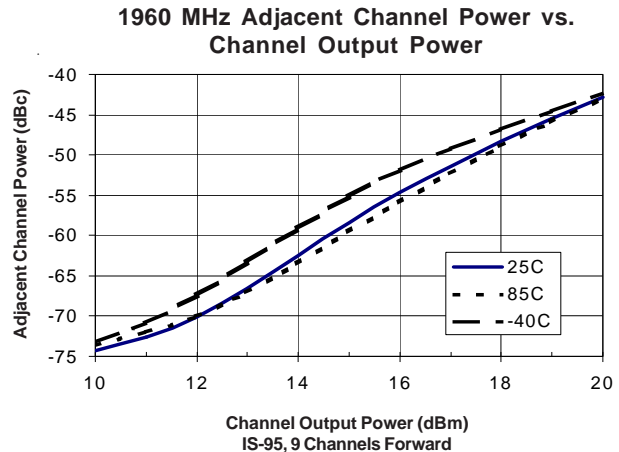
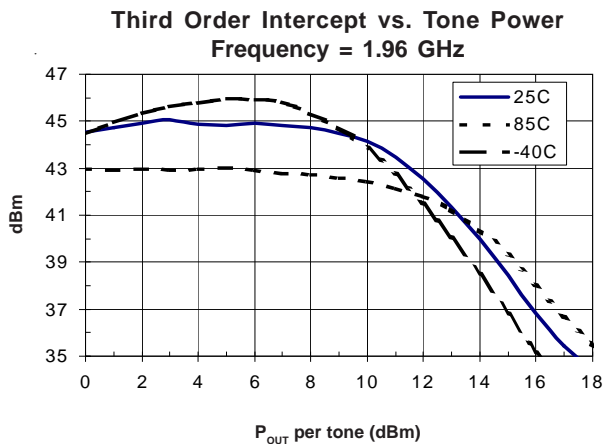
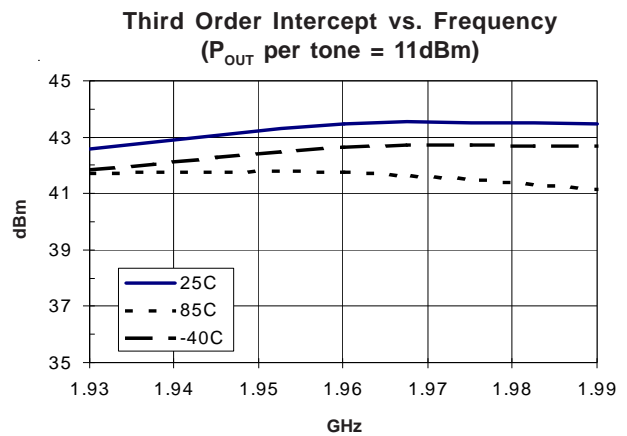
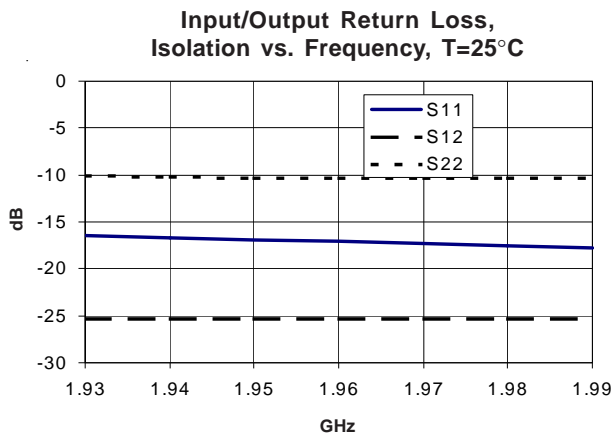
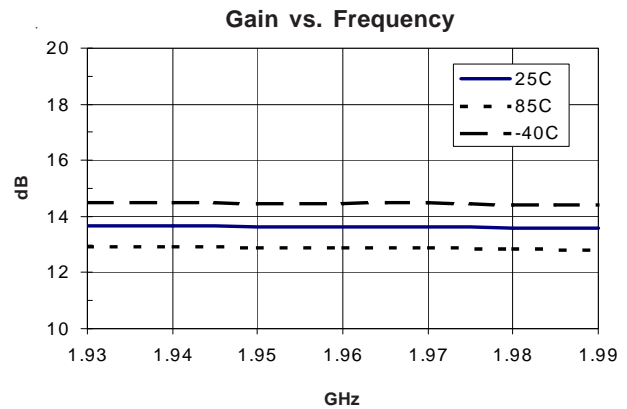
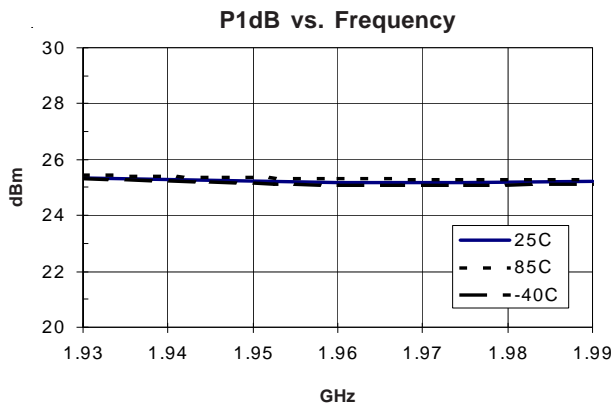
## Recommended Mounting Configuration for Optimum RF and Thermal Performance



850MHz Application Circuit Data,  $V_{CC}=5V$ ,  $I_D=115mA$  (Tuned for Output IP3)

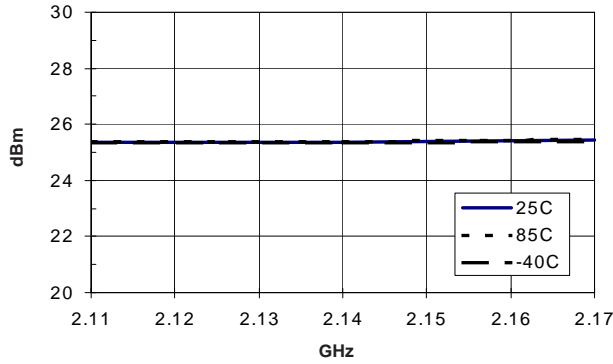


1960MHz Application Circuit Data,  $V_{CC}=5V$ ,  $I_D=115mA$  (Tuned for Output IP3)

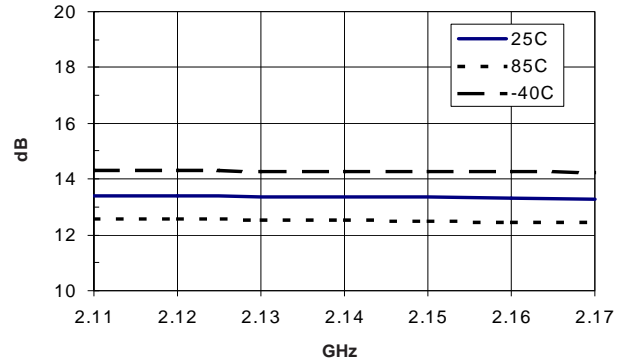


2140MHz Application Circuit Data,  $V_{CC}=5V$ ,  $I_D=115mA$  (Tuned for Output IP3)

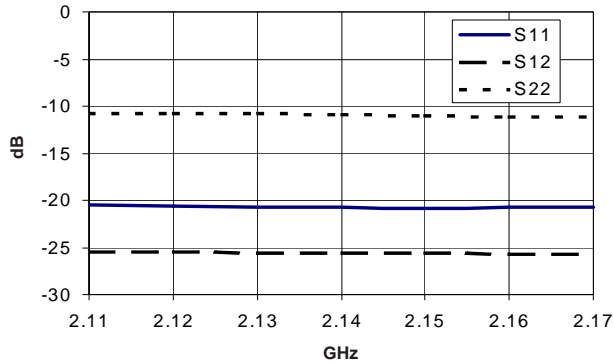
**P1dB vs. Frequency**



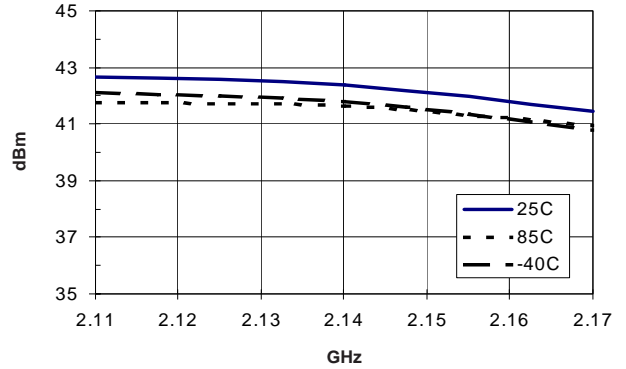
**Gain vs. Frequency**



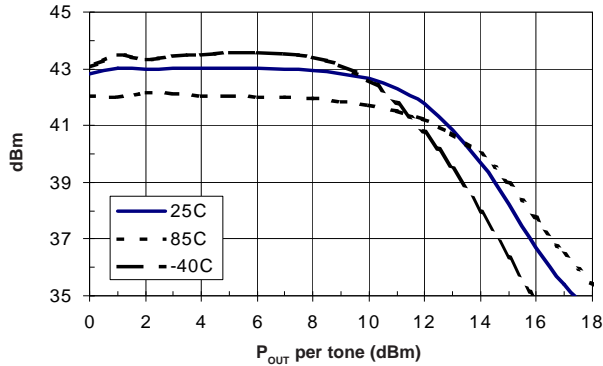
**Input/Output Return Loss, Isolation vs. Frequency, T=25°C**



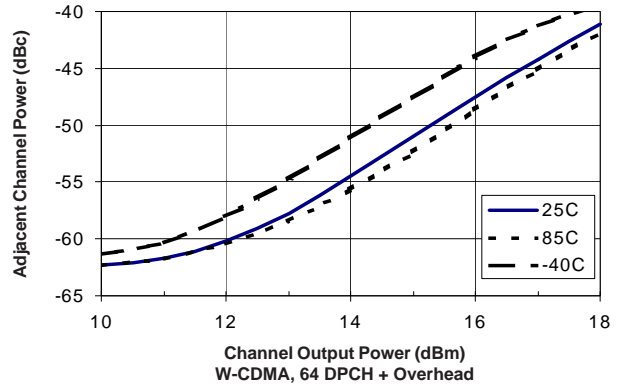
**Third Order Intercept vs. Frequency (P<sub>OUT</sub> per tone = 11dBm)**



**Third Order Intercept vs. Tone Power Frequency = 2.14 GHz**

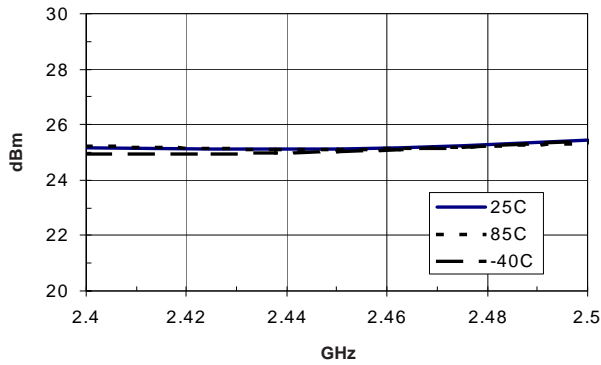


**2140 MHz Adjacent Channel Power vs. Channel Output Power**

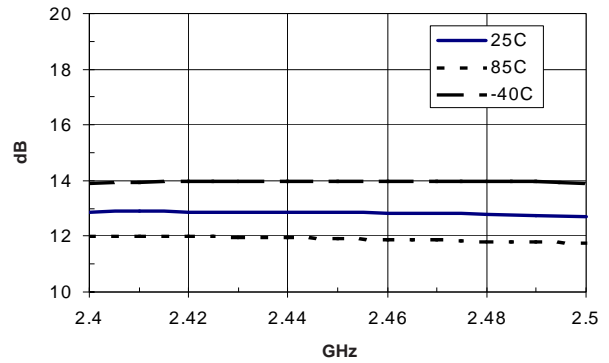


2450MHz Application Circuit Data,  $V_{CC}=5V$ ,  $I_D=115mA$  (Tuned for Output IP3)

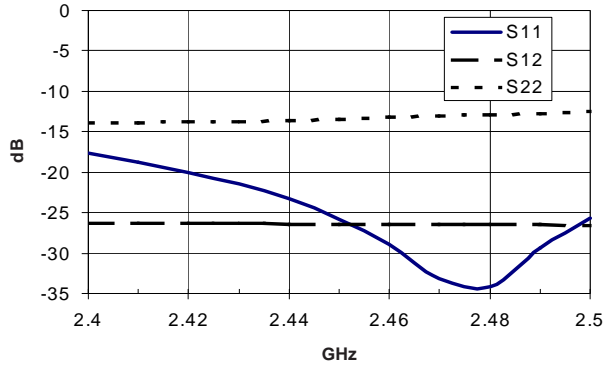
**P1dB vs. Frequency**



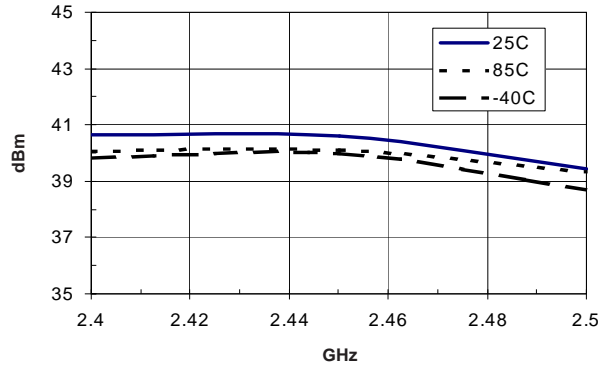
**Gain vs. Frequency**



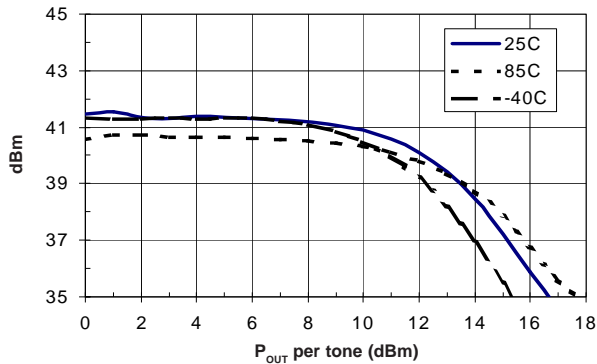
**Input/Output Return Loss, Isolation vs. Frequency, T=25°C**



**Third Order Intercept vs. Frequency (P<sub>OUT</sub> per tone = 11dBm)**

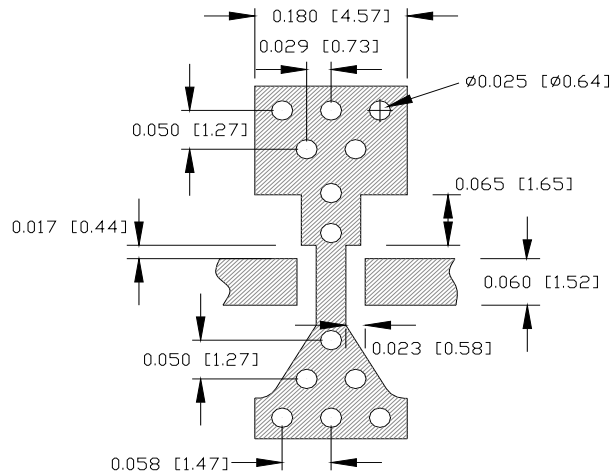


**Third Order Intercept vs. Tone Power Frequency = 2.45 GHz**



Pin	Function	Description
1	Base	Base pin
2	GND and Emitter	Connection to ground. Use via holes to reduce lead inductance. Place via holes as close to ground leads as possible.
3	Collector	Collector pin
4	GND and Emitter	Connection to ground. Use via holes to reduce lead inductance. Place via holes as close to ground leads as possible.

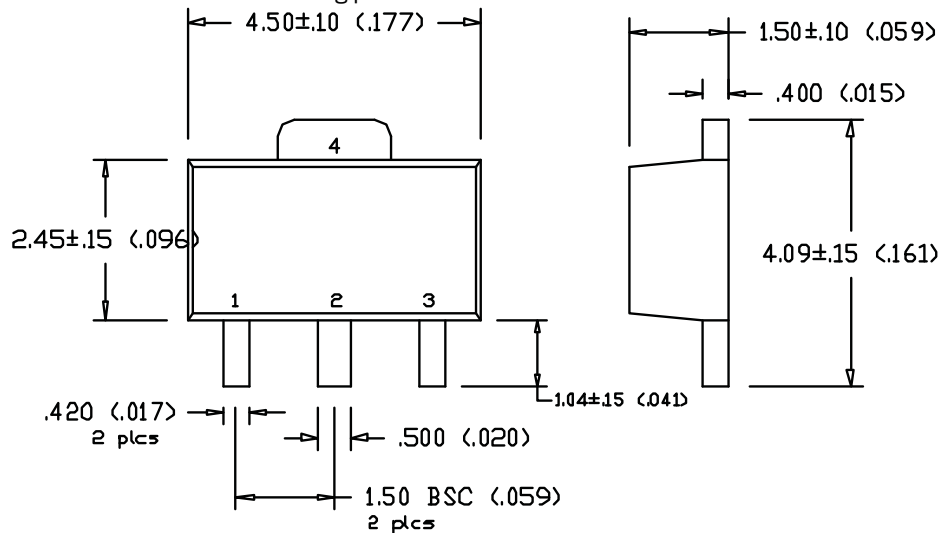
### Suggested Pad Layout



### Package Drawing

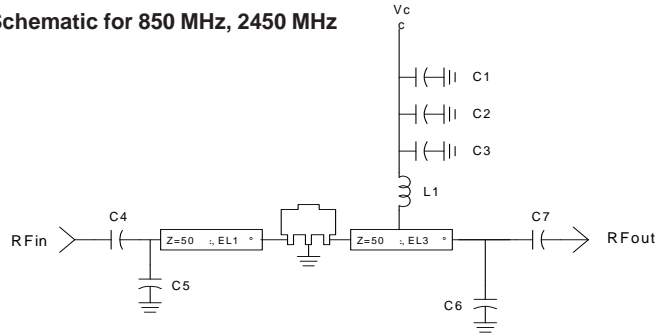
Dimensions in inches (millimeters)

Refer to drawing posted at [www.rfmd.com](http://www.rfmd.com) for tolerances.



## 850MHz Application Schematic

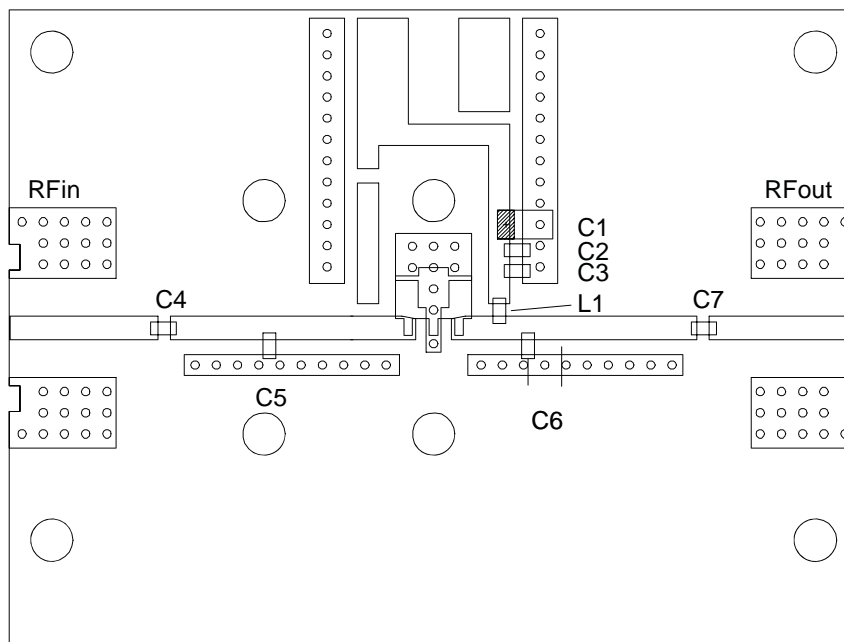
Application Schematic for 850 MHz, 2450 MHz



Ref. Des.	Vendor Series	850 MHz	2450 MHz
C1	Matsuo 267M3502104K	0.1uF 10%	0.1uF 10%
C2	Rohm MCH18	1000pF 5%	1000pF 5%
C3, C7	Rohm MCH18	47pF 5%	22pF 5%
C4	Rohm MCH18	47pF 5%	1.2pF ±0.25pF
C5	Rohm MCH18	5.6pF ±0.25pF	-

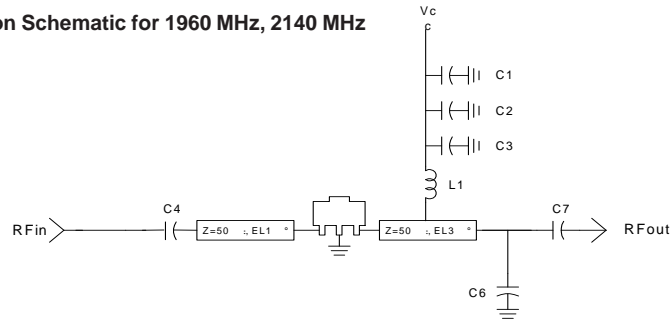
Ref. Des.	Vendor Series	850 MHz	2450 MHz
C6	Rohm MCH18	3.9pF ±0.25pF	1.0pF ±0.25pF
C6 Position		1	2
L1	Toko LL1608-FS	33nH 5%	15nH 5%
EL1		15	76
EL3		7.2	31.5

## 850MHz Evaluation Board Layout



## 1960MHz and 2140MHz Application Schematic

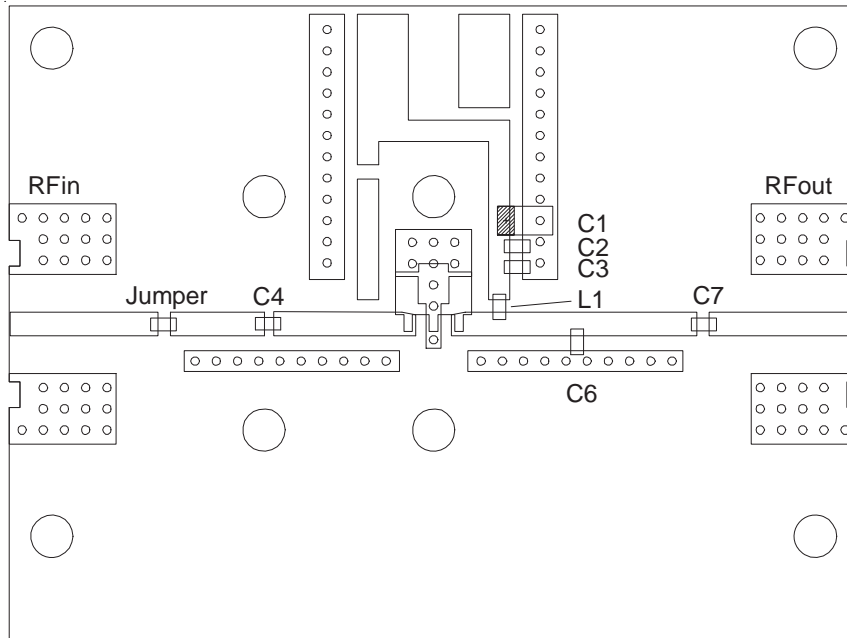
Application Schematic for 1960 MHz, 2140 MHz



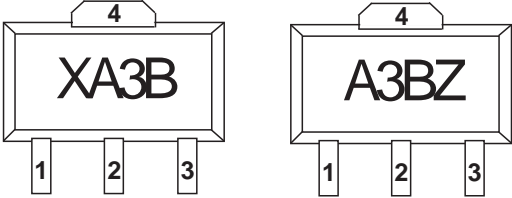
Ref. Des.	Vendor Series	1960/2140 MHz
C1	Matsuo 267M3502104K	0.1uF 10%
C2	Rohm MCH18	1000pF 5%
C3, C7	Rohm MCH18	22pF 5%
C4	Rohm MCH18	2.2pF ±0.25pF
C5	Rohm MCH18	-

Ref. Des.	Vendor Series	1960/2140 MHz
C6	Rohm MCH18	1.0pF ±0.25pF
L1	Toko LL1608-FS	18nH 5%
EL1		35
EL3		30

## 1960MHz and 2140MHz Evaluation Board Layout



### Part Identification



Alternate marking "SXA389BZ" or "SXA389B" on line one with Trace Code on line two.

### Ordering Information

Part Number	Description	Devices/Container
SXA-389BZSB		5 Piece Sample Bag
SXA-389BZSQ		25 Piece Sample Bag
SXA-389BZSR		100 Piece 7" Sample Reel
SXA-389BZ		1000 Piece 7" Sample Reel
SXA-389BZPCK1	850MHz PCBA	Evaluation Board and 5 Piece Sample Bag
SXA-389BZPCK2	1960MHz PCBA	Evaluation Board and 5 Piece Sample Bag

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